Vishay Siliconix

# Automotive P-Channel 12 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-12				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.00832				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -2.5 \text{ V}$	0.01000				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -1.8 \text{ V}$	0.01430				
I <sub>D</sub> (A)	-25				
Configuration	Single				
Package	SO-8				

#### **FEATURES**

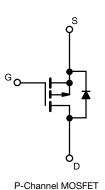
- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ROHS COMPLIANT HALOGEN FREE





ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V <sub>DS</sub>	-12			
Gate-Source Voltage	$V_{GS}$	± 8	V		
Continuous Drain Current <sup>a</sup>	T <sub>C</sub> = 25 °C	1	-25		
	T <sub>C</sub> = 125 °C	- I <sub>D</sub>	-14		
Continuous Source Current (Diode Conduction	I <sub>S</sub>	-6.5	Α		
Pulsed Drain Current <sup>b</sup>	I <sub>DM</sub>	-100			
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	-19		
Single Pulse Avalanche Energy	L=0.11IIII	E <sub>AS</sub>	18	mJ	
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	P <sub>D</sub>	7.1	W	
	T <sub>C</sub> = 125 °C		2.3	] vv	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount c	$R_{thJA}$	85	°C/W	
Junction-to-Foot (Drain)		$R_{thJF}$	21	C/ VV	

#### Notes

- a. Package limited.
- b. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- c. When mounted on 1" square PCB (FR4 material).



# Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$ , $I_D = -250 \mu A$		-12	-	-	V	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$		-0.4	-0.6	-0.9	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$		-	-	± 100	nA	
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = -12 V	-	-	-1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = -12 V, T <sub>J</sub> = 125 °C	-	-	-50	μA	
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = -12 V, T <sub>J</sub> = 175 °C	-	-	-150	•	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = -4.5 V	V <sub>DS</sub> ≥ -5 V	-30	-	-	Α	
		V <sub>GS</sub> = -4.5 V	I <sub>D</sub> = -14 A	-	0.00510	0.00832		
		V <sub>GS</sub> = -4.5 V	I <sub>D</sub> = -14 A, T <sub>J</sub> = 125 °C	-	-	0.00900	•	
Drain-Source On-State Resistance a	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5 V	I <sub>D</sub> = -14 A, T <sub>J</sub> = 175 °C	-	-	0.01100	Ω	
		V <sub>GS</sub> = -2.5 V	I <sub>D</sub> = -13 A	-	0.00650	0.01000		
		V <sub>GS</sub> = -1.8 V	I <sub>D</sub> = -12 A	-	0.00940	0.01430		
Forward Transconductance a	9fs	V <sub>DS</sub> = -6 V, I <sub>D</sub> = -10.5 A		-	54	-	S	
Dynamic <sup>b</sup>								
Input Capacitance	C <sub>iss</sub>			-	7500	11 000		
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = -6 V, f = 1 MHz	-	2800	4200	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	2400	3600		
Total Gate Charge <sup>c</sup>	Qg			-	101	151		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{GS} = -4.5 \text{ V}$	$V_{DS} = -6 \text{ V}, I_D = -10.5 \text{ A}$	-	15	-	nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			-	45	=		
Gate Resistance	$R_g$	f = 1 MHz		1.1	2.2	3.2	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			-	31	42		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = -6 \text{ V}, \text{ R}_{L} = 15 \Omega$ $I_{D} \cong -10.5 \text{ A}, \text{ V}_{GEN} = -4.5 \text{ V}, \text{ R}_{g} = 6 \Omega$		-	168	224	ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			-	310	412		
Fall Time <sup>c</sup>	t <sub>f</sub>			-	283	376		
Source-Drain Diode Ratings and Char	acteristics <sup>b</sup>							
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	-100	Α	
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> = -10.5 A, V <sub>GS</sub> = 0			-0.8	-1.2	V	

#### Notes

- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

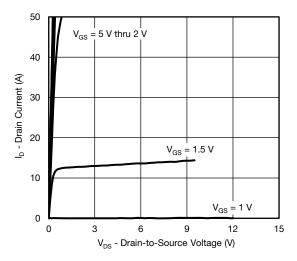
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

5

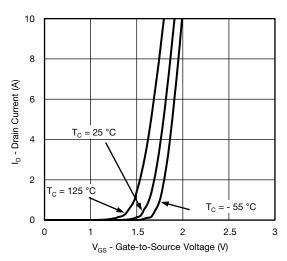
4



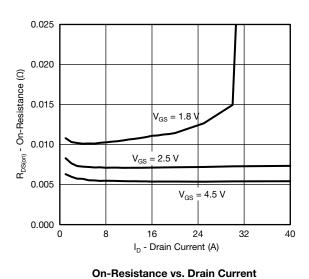
# **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

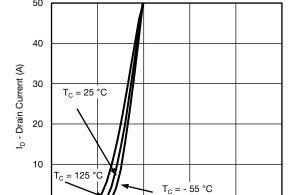


#### **Output Characteristics**



## Transfer Characteristics





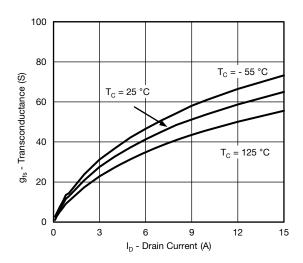
2

0

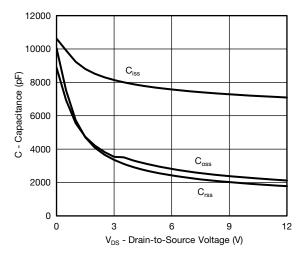
0

# V<sub>GS</sub> - Gate-to-Source Voltage (V) Transfer Characteristics

3



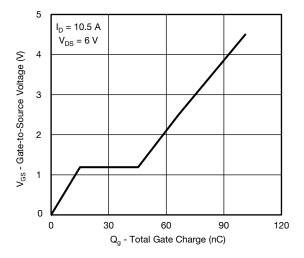
#### Transconductance



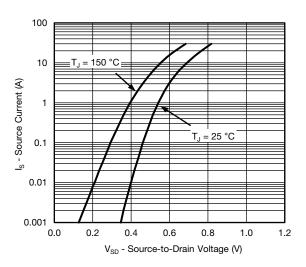
For technical questions, contact: automostechsu



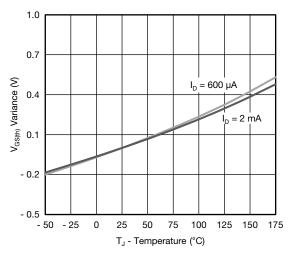
# **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



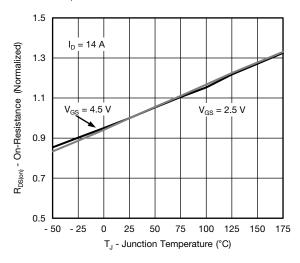
#### **Gate Charge**



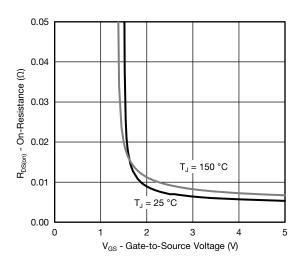
#### **Source Drain Diode Forward Voltage**



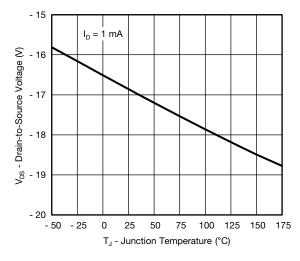
**Threshold Voltage** 



On-Resistance vs. Junction Temperature



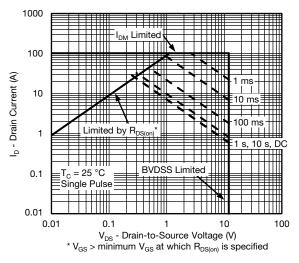
On-Resistance vs. Gate-to-Source Voltage



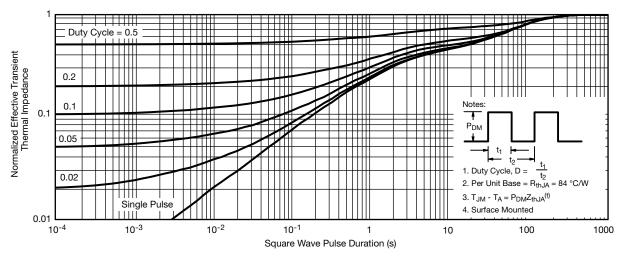
Breakdown Voltage vs. Junction Temperature



# **THERMAL RATINGS** ( $T_A = 25$ °C, unless otherwise noted)



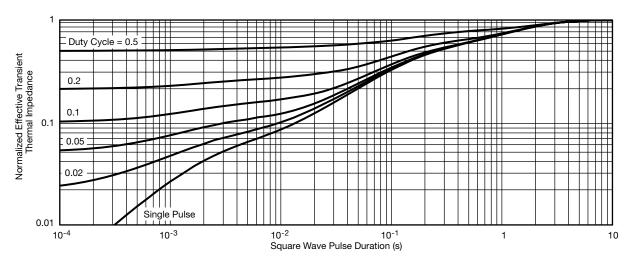
**Safe Operating Area** 



Normalized Thermal Transient Impedance, Junction-to-Ambient

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## **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Foot (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?66897">www.vishay.com/ppg?66897</a>.





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REVISION HISTORY a					
REVISION	DATE	DESCRIPTION OF CHANGE			
В	15-Jan-16	Maximum on-resistance changed     I <sub>GSS</sub> test condition changed			

#### Note

a. As of April 2014



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	MILLIMETERS INCHES			TERS INCHES	
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

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